軟板用顯像型防焊油墨 Photoimageable Flexible Solder Resist Ink

R-500 FP 系列 (2 液型 / 軟板液態感光防焊油墨)

R-500 FP Series (2 component / liquid photoimageable flexible solder mask)

- (1) 適用於網版印刷。
- (2) 具高感度及優良的耐化性。
- (3) 適合軟性電路板用。
- (4) 耐熱烘烤不易變色。

- (1) For screen printing.
- (2) High sensitivity and excellent gold plating resistance.
- (3) Suitable to flexible printed circuit boards.
- (4) Lower color change during the high temperature process.

特性(Specification):

系列名稱(Product name) 項目(Item)		R-500 FP 系列
顏色 (Color)		各式深淺之綠色、黃色、白色、藍色其它特殊及消光色系green、yellow、white、blue and other special and mat colors
硬化劑 (Hardener)		HD-5
混合比率 (Mixing ratio)		主劑 0.85: 硬化劑 0.15 main agent 0.85: hardener 0.15 (by weight)
黏度(主劑) / (25℃、R 型黏度計 5r.p.m 值) Viscosity (main agent) / (R-type viscometer 5min¹/25℃)		200~250 PS
固成份 (Solid Content)		75~80 wt%
比重 (混合後) (Density (mixture))		1.3 ± 0.2
最大預烤範圍* (Tack dry window)*		75°C* 80 mins. Max.
曝光量 (能量計: ORC UV351) (Exposure (detector : ORC UV351))		400~800 mJ /cm² (油墨上 / on solder mask)
混合後使用期限 (Pot life)		24 小時 (25℃以下暗處保存) 24 hours after mixing (Stored at dark place , 25℃ or below)
保存期限 (Shelf life)		製造後6個月 (25℃以下暗處保存) 6 months after production (Stored at dark place, 25℃ or below)
項目 _ (Items) _	試驗條件 _ (Test method)	結果 _ (Test result)
鉛筆硬度 (Pencil Hardness)	廠內方法 OWI0805-018A	4H
密著性 (Adhesion)	廠內方法 OWI0805-016A	100 / 100
焊錫耐熱性 (Solder heat resistance)	260°C ⋅ 10 sec ⋅ 1 cycles	O.K.
耐酸性 (Acid resistance)	10vo1% H2SO4 20°C 20 min	O.K.
耐鹼性 (Alkaline resistance)	10wt% NaOH 20°C 20 min	O.K.
耐溶劑性 (Solvent resistance)	PGM-Ac 20°C 20 min	O.K.
絕緣電阻	IPC CLASS 3 method	初始值 (Initial):2.7×10¹³Ω
(Insulation resistance)	IPC B Pattern	處理後 (Conditioned): $2.6 \times 10^{12} \Omega$

^{*}最大預烤範圍:以1% K₂CO₃、30℃、60秒、2.0Kg/cm²顯影。

^{*}Tack dry window: Developed by 1% K₂CO₃(aq)、30°C 、60秒、2.0Kg/cm²。